Product Description: ZX122S3MP is PCISIG M.2 power measurement module providing access to PCISIG M.2 power supply rails for purpose of characterizing, test & measurement of PCISIG M.2 supply voltages

Measure and analyze power supply ripple, transients, Device Under Test, DUT, power consumption and more.

- a) Each power supply rail is designed with current sensing power resistor, please see block diagram.
- b) Utilizing scope probe test equipment, measure power supply noise, ripples, transients, and DUT power consumption.
- c) Utilizing eLoad (Electronic Load), qualify host's power supply & maximum output power.
- d) Identify power supply trace impedance, Rdc , for improved Host / DUT PCB design.

ZX122S3MP features:

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- 1- Pass through PCISIG signals enabling real-time power supply test and measurement.
- 2- Onboard current sense resistors for all supply rails Please see table 1 for details.
- 3- All other traces are pass through designed for 50 Ohms impedance controlled.
- 4- Four layers PCB design, inner layers are GND planes + Exposed copper on top and bottom fill
- 5- Accessible GND exposed copper, enabling for ease of probe access for test and measurement.
- 6- Mates with any key matching M.2 Host and Device / DUT
- 7- The module is shipped with 12pc of probing wires, ZX00BC2PH30, See ordering information

Bare solid copper to pin header wire

Electrical: Insertion loss > -2dB @6GHz

Trace impedance: 50Ω

Operating Temperature: -65 °C to +170 °C M.2 Edge Connector type (J1): Key C

Mates with: M.2 Key C

Plating: Gold 100U M.2 Receptacle (J2): Key Type: Key C

Height: 0.16" (4.2mm)

Spacer: 0.1" (2.54mm) - See Figure 3

Plating: Gold 100U

Current per pin: 0.5A (maximum)

Current Sense:

R1, R2: 10mΩ 2512 SMD 7W - Thickness: 0.02" (0.5mm) Max - See Figure 3 R3: 10mΩ 2818 SMD 10W - Thickness: 0.059" (1.5mm) Max - See Figure 3

R4:8mΩ 0805 SMD 1W Ratings: AEC-Q200

Temperature Coefficient: ±75ppm / °C

Operating Temperature: -65 °C to +85 °C at 100% listed power rating, see Table 1 -65°C to +170°C see section Power Rating on page 3

Shunt:

Package: 0402 SMD

Current Sense resistors: Table 1 lists onboard ZX122S3MP current sense resistors and associated PCISIG M.2 connector assignment

Table 1

Comment Compa Pagiston	PCISIG M.2 Connector pin	DOICIO M O Cumply Dail	Description	Package	
Current Sense Resistor	number	PCISIG M.2 Supply Rail	Description	(inch)	(mm)
R1	2, 4,	3.3 V	10m Ohms 1% 7W	2512	6432
R2	70, 72, 74	3.3 V	10m Ohms 1% 7W	2512	6432
R3	12, 14, 16, 18	3.3 V	10m Ohms 1% 10W	2818	7146
R4	22	1.8 V	8m Ohms 1% 1W	805	2012

Figure 3- M.2 receptacle Rsense **Thickness**

Compliance:

ISO2001 certified

RoHs - Lead Free

UL E111594 document

RoHs Directive 2011/65/EU

Certificate REACH SVHC

WEEE Directive (2012/12/EU)

ELV- Vehicle Directive (Directive 2000/EC)

Certificate of Compliance for Radioactive substances

Certificate of Compliance for Ozone Depleting Substances, ODS

European Union Directive (203/11/EC)

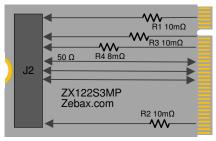
Certificate of Compliance for Asbestos

Certificate of Compliance RoHS EN CoC

Halogen Free per IEC-61249-2.21: 2003

EU RoHS2





 $50~\Omega~$: All traces are designed $50~\Omega$ impedance control J2: PCISIG M.2 receptacle connector

Figure 1 - ZX122S3MP Block diagram

R1. R2: current sense 3.3V VBAT R3: current sense 3.3V / VBAT



ZX122S3MP

Zebax.com

ZX122S3MP package includes:

ZEBAX.com

ZX122S3MP

Part number ZX122S3MP ZX00BC2PH30

PCB Edge Key C

J2 Key C

Quantity Description

1.029" (26mm)

(30mm)

M.2 PCISIG Socket 3 power measurement module

12 30AWG Bare Copper wire to pin header wire assembly

ZX00BC2PH30 site page for ordering ZX00BC2PH30 wire assembly

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SPECIFIED DIMENSIONS ARE INCHES (MM). ROHS COMPLIANT

ASSEMBLY DRAWING

ITEM: ZX122S3MP

PCISIG M.2 NGFF Socket 3 Key C passive **DESCRIPTION:** power measurement module

CHECKED:

DRAWN: M. MARINA MATTHEW CT

REVISSION: 1.0 SHEET: 1 OF 3

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Current Sense resistors: The current sense resistors may be removed if external electronic

load, eLoad, is used. eLoad test equipment may be applied to ZX122S3MP for power supply characterization, test and measurements, Eload suppliers; BK Precision, Chroma, Instek, Kikusui and more

Figure 4 – Typical application - Rx, Ry: Current sense resistors

ZX122S3MP

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Signal assignments: Table 2 exhibits the routed M.2 PCISIG signals on the ZX122S3MP module.

Please note: Table 2 represents only the PCISIG M.2 Socket 3 Key C power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 3 Key C" applications.

Ground / Exposed Copper:

All of the PCISIG M.2 GND, reference ground, signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S3MP is the module's GND for purpose of rework and probing purpose.

PCISIG M.2 signals:

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ZX122S3MP passes through all PCISIG M.2 signals (excluding the power supply rails . All traces are 50 Ohms impedance controlled. ZX122S3MP passes through limited number of NC, No Connect, signals. Please see NC. No Connect section below for more details.

NC. No Connect:

Due to space constraints, ZX122S3MP does not pass through all the NC PCISIG M.2 signals. By definition, these signals are Not Connect, therefore they could be left open ended. The NC signals which ZX122S3MP does not support have open connection at both J1 and J2 connectors. All the listed signals marked Note 3 in table 2 have not been routed from J1 to J2. The listed signals are open at J1 and J2 connectors.

Application: Bringup, testing, emulation, development, modular design evaluations

M.2 PCISIG Socket power supply test characterization

SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module

Socket 3 Add-in Card Key C-E, Socket 3 DisplayPort Key C, Socket 3 SDIO Key E

Socket 2 WWAN Key C, Socket 2 PCle-based SSD Key B-M, Socket 2 SATA-based SSD Key B-M

Socket 2 PCIe / USB 3.1 Gen1-Based WWAN Key B , Socket2 PCIe-Based WWAN Key B

Socket 2 USB3.1 Gen1-based WWAN Key B , Socket 2 SSIC WWAN Key B

Socket 3 PCle-based Key M, Socket 3 SATA-based Key M

Mates with: Any standard M.2 NGFF PCISIG connector on host and device Key C

TE 2199125 2199119 2199230 2199133 JAE SM3ZS067

Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol

Module Insertion, Removal process:

In order to avoid any mechanical stress or damage to ZX122S3MP, please follow the below listed guidelines for insertion and removal process:

- 1- Move the Module against the housing chamber, see figure 1
- 2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3
- 3- Rotate the module to horizontal position, see figure 4
- 4- Fix the module by screw, see figure 5

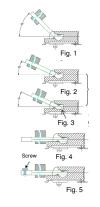


Table 2 – PCISIG M.2 Socket 3 Key C

Please note: Table 2 represents only the PCISIG M.2 Socket 3 Key C power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 3 Key C" applications.

		Socke		_		
	PO	PCISIG M.2 connector pin			oin	
Signal	Pin	ZX122S3MP		MP	Di-	Signal
		Label ¹		Label ¹	Pin	
3.3 V	74			75	GND	
3.3 V	72	R2	R2 71		71	GND
3.3 V	70	1	l i		65	
	66				63	ADD_IN CARD KEY M
ADD_IN CARD KEY M	64	1			61	ADD_IN CARD RET IVI
	62				59	
	60				57	GND
NC	48	Note 3			51	GND
NC	46	Note 3			45	GND
GND	38	EP ²			39	GND
GND	32		33 GND EP ² 27 GND		GND	
VIO 1.8 V	22	R4			GND	
NC	28	Note 3			21	GND
NC	26	Note 3	3 15 GND		GND	
NC	24	Note 3			9	GND
NC	20	Note 3		3	GND	
3.3 V	18		1		1	GND
3.3 V	16	R3				
3.3 V	14	หง				
3.3 V	12					
3.3 V	4	D4				
3.3 V	2	R1				

Note 1: Label is the listed reference designator for the current sense resistors

- 2- Exposed Copper is connected to inner GND planes, see Exposed Copper
- 3- The listed NC, No Connect, assigned signals for PCISIG M.2 Socket 3 Key M are not connected between J1 and J2 connectors, therefore they listed pin in open at J1 and J2 connectors.

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SPECIFIED DIMENSIONS ARE INCHES (MM). ROHS COMPLIANT

ASSEMBLY DRAWING

ITEM: ZX122S3MP

PCISIG M.2 NGFF Socket 3 Key C passive **DESCRIPTION:** power measurement module

CHECKED:

MATTHEW CT

REVISSION: 1.0

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M. MARINA

SHEET: 2 OF 3

Product Name: ZX122S3MP PCISIG M.2 NGFF Socket 3 Key A passive power measurement module – Page 3 of 3

Typical Application: ZX122S3MP is designed for purpose of PCISIG M.2 power supply characterization, test and debug at full

> connector's bandwidth. It provides onboard current sense resistors where scope probe could be utilized for measuring characterization data for qualifying the host or device functional behavior. Additionally, the current sense resistors may be replaced by eLoad for transient and dynamic load throttling. Below are few suggestions in respect to proper power supply measurements using ZX122S3MP module:

Scope Probe wire Installation:

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Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible - Based on availability of type of scope + probing options, install probe wire as listed below

- 1- It is recommended to keep the +probe wire length at 0.5" (1.2cm) long.
- 2- In order to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND reference. ZX122S3MP provides several exposed copper test points for probing purpose.
- 3- Ensure scope probe's bandwidth is set at 20MHz Certain tests require full scope + scope probe bandwidth; however, industry standard is 20MHz bandwidth for power supply test and measurements.
- 3- Both Keysight as well as Tektronix offer variety of single ended as well as differential probes along with their accessories, below are few probes from each vendor:
 - a) Keysight differential probe or similar N2795A, N2796A, 1168V, 1134B along with E2677B differential Solder-in probe, N5426A ZIF Tip, N2884A Fine Wire ZIF Tip and more - See the figure "probe head accessories".
 - b) Tektronix offers several single-ended as well as differential probes such as: P6243, P6245, P6248, P6246, P6247 or any TP1500, TAP2500, TAP3500, TAP4000, P7240 of TDP7000 series or equivalent
- 4- Please follow your vendor's guideline in installation of probe wires & accessories.

Power Rating: Onboard current sense resistors on ZX122S3MP module are designed for maximum power consumption per PCISIG M.2 specification operating within -65 °C to 70 °C temperature range. The current sense resistor's power rating will degrade at above 85 °C test environment. It is highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin (0.5A per pin) at above 85 °C test environment.

The onboard current sense resistors operate at 100% listed power ratings (see Table 1) within temperature range :

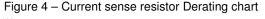
R1. R2: -65° C \leq operating temperatures \leq 85 $^{\circ}$ C with tolerance = \pm 1%

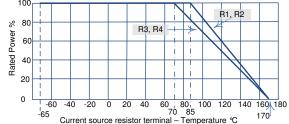
R3. R4: -65° C \leq operating temperatures \leq 70 $^{\circ}$ C with tolerance = \pm 1%

The onboard current sense resistors **power ratings** derail at **above** 70 ℃. Figure 4 exhibits the current sense resistors derating curve. Current sense resistors rated power; $P = VI = I^{**}2 \times R$ where I is the maximum current for the listed resistor value R

Below are few suggestions, if your test & measurement environment falls ≥ +70 °C temperature range:

- 1- Apply cooling fan where the current sense resistor's terminal blocks are measured at 70 °C Please note The ZX122S3MP module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method.
- 2- Replace the onboard current sense resistors with lower values (similar footprint), resulting at higher power ratings at ≥ 70 °C test environment.
- 3- Replace onboard current sense resistors with eLoad (electronic Load Board / System) eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation.





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Keysight Probe Head accessories InfiniiMax RC Probe Heads InfiniiMax I Probe Heads N5381B Diff. Solder-In E2677B Diff. Solder-In MX0100A Diff. Micro MX0103A Bullet Adapter E2678B Diff. Socketed N5380B SMA MX0106A Diff. Solder-In 18 10 00000 E2675B Diff, Browser N5425B ZIF =-N2839A Diff. Browser N2884A Fine Wire ZIF Tip N5451A Long-Wired ZIF Tip (7 mm) MX0105A Diff. SMA



N5451A Long-Wired

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SPECIFIED DIMENSIONS ARE INCHES (MM). ROHS COMPLIANT

ASSEMBLY DRAWING

ITEM: ZX122S3MP

DESCRIPTION:

PCISIG M.2 NGFF Socket 3 Key C passive power measurement module

CHECKED: M. MARINA REVISSION: 1.0

MATTHEW CT

SHEET: 3 OF 3

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